

2SC5440

Silicon NPN triple diffusion mesa type

For horizontal deflection output

■ Features

- High breakdown voltage, and high reliability through the use of a glass passivation layer
- High-speed switching
- Wide safe operation area (ASO)

■ Absolute Maximum Ratings $T_C = 25^\circ\text{C}$

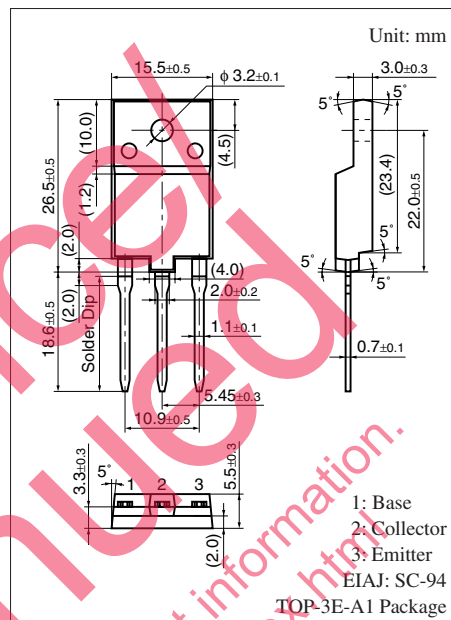
Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	V_{CB0}	1500	V
Collector-emitter voltage (E-B short)	V_{CES}	1500	V
Collector-emitter voltage (Base open)	V_{CEO}	600	V
Emitter-base voltage (Collector open)	V_{EBO}	7	V
Base current	I_B	7.5	A
Collector current	I_C	15	A
Peak collector current *	I_{CP}	25	A
Collector power dissipation	P_C	60	W
		$T_a = 25^\circ\text{C}$	3.0
Junction temperature	T_j	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

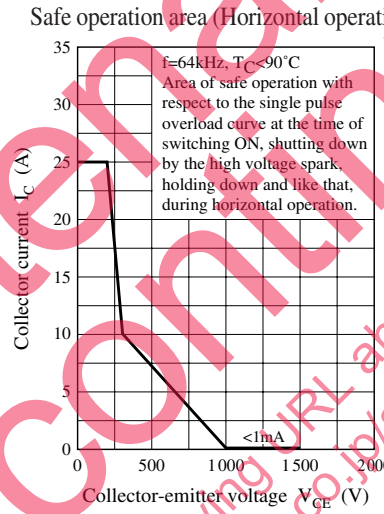
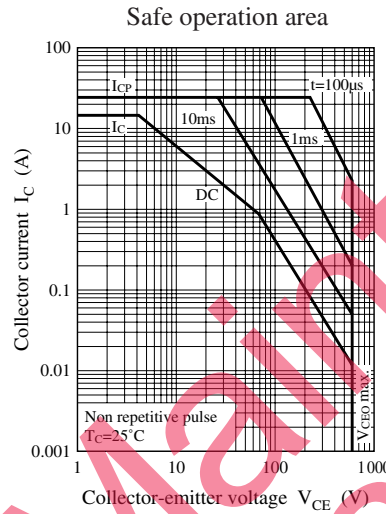
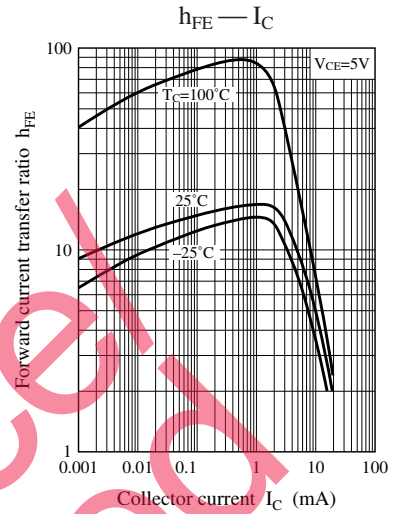
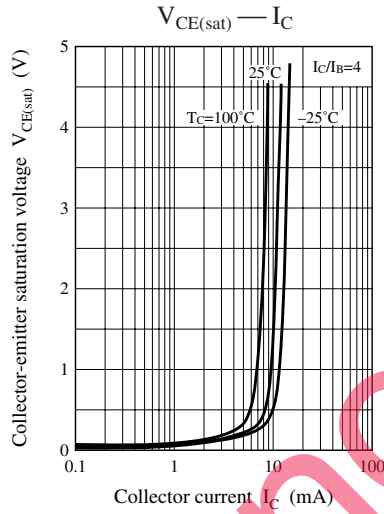
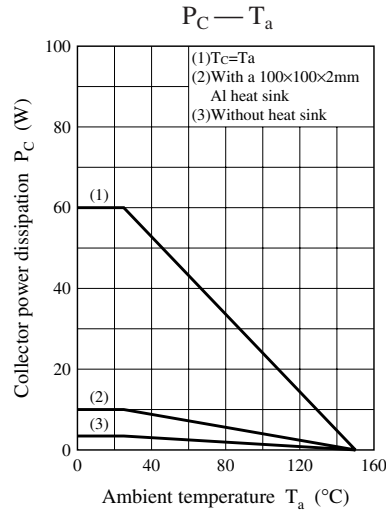
Note) *: Non-repetitive peak collector current

■ Electrical Characteristics $T_C = 25^\circ\text{C} \pm 3^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-base cutoff current (Emitter open)	I_{CB0}	$V_{CB} = 1000\text{ V}, I_E = 0$			50	μA
		$V_{CB} = 1500\text{ V}, I_E = 0$			1	mA
Emitter-base cutoff current (Collector open)	I_{EBO}	$V_{EB} = 7\text{ V}, I_C = 0$			50	μA
Forward current transfer ratio	h_{FE}	$V_{CE} = 5\text{ V}, I_C = 7.5\text{ A}$	5		9	—
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C = 7.5\text{ A}, I_B = 1.88\text{ A}$			3	V
Base-emitter saturation voltage	$V_{BE(sat)}$	$I_C = 7.5\text{ A}, I_B = 1.88\text{ A}$			1.5	V
Transition frequency	f_T	$V_{CE} = 10\text{ V}, I_C = 0.1\text{ A}, f = 0.5\text{ MHz}$		3		MHz
Storage time	t_{stg}	$I_C = 7.5\text{ A}, \text{Resistance loaded}$			2.7	μs
Fall time	t_f	$I_{B1} = 1.88\text{ A}, I_{B2} = -3.76\text{ A}$			0.2	μs

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.





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